


# PRODUCT / PROCESS CHANGE INFORMATION

## 1. PCI basic data

|                      |  |
|----------------------|--|
| 1.1 Company          |  STMicroelectronics International N.V |
| 1.2 PCI No.          | ANALOG MEMS SENSORS/24/15035   |
| 1.3 Title of PCI     | Standardization of new inner packing box including bubble wrap for MEMS inertial products with package 2x2mm.          |
| 1.4 Product Category | Pls refer to the products list.  |
| 1.5 Issue date       | 2024-10-25   |

## 2. PCI Team

|                           |                          |
|---------------------------|--------------------------|
| 2.1 Contact supplier      |                          |
| 2.1.1 Name                | ROBERTSON HEATHER        |
| 2.1.2 Phone               | +1 8475853058            |
| 2.1.3 Email               | heather.robertson@st.com |
| 2.2 Change responsibility |                          |
| 2.2.1 Product Manager     | Simone FERRI             |
| 2.1.2 Marketing Manager   | Tarik SOUBES             |
| 2.1.3 Quality Manager     | Fabio BIGANZOLI          |

## 3. Change

|              |   |                            |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change  | 3.3 Manufacturing Location |
| Materials    | Any indirect material modifications for shipping products in dimensions, material, composition, orientation | CALAMBA                    |

## 4. Description of change

|   |                |                                |
|---|----------------|--------------------------------|
|   | Old            | New                            |
| 4.1 Description   | No bubble wrap | Bubble wrap and FRAGILE label. |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact      |                                |

## 5. Reason / motivation for change

|                      |   |
|----------------------|---|
| 5.1 Motivation       | The change in reel packing is implemented to guarantee more protection against the impacts during the transport and shipment. |
| 5.2 Customer Benefit | LOGISTICS IMPROVEMENT   |

## 6. Marking of parts / traceability of change

|                 |           |
|-----------------|-----------|
| 6.1 Description | Date Code |
|-----------------|-----------|

## 7. Timing / schedule

|                                     |                |
|-------------------------------------|----------------|
| 7.1 Date of qualification results   | 2024-11-25     |
| 7.2 Intended start of delivery      | 2024-12-09     |
| 7.3 Qualification sample available? | Not Applicable |

## 8. Qualification / Validation

|  |             |            |  |
|--|-------------|------------|--|
| 8.1 Description                                    |             |            |  |
| 8.2 Qualification report and qualification results | In progress | Issue Date |  |

## 9. Attachments (additional documentations)

15035 Public product.pdf

| 10. Affected parts      |                         |                          |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current           |                         | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No  |
|                         | LIS2DU12TR              |                          |
|                         | LIS2DUX12TR             |                          |
|                         | LIS2DUXS12TR            |                          |

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## Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

**PCI Title :** Standardization of new inner packing box including bubble wrap for MEMS inertial products with package 2x2mm.

**PCI Reference :** ANALOG MEMS SENSORS/24/15035

**Subject :** Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

|             |            |              |
|-------------|------------|--------------|
| LIS2DUX12TR | LIS2DU12TR | LIS2DUXS12TR |
|-------------|------------|--------------|

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